



D5V0S1UN2LP1610

1 CHANNEL HIGH SURGE TVS DIODE

Product Summary

V _{BR (Min)}	I _{PP (Max)}	C _{T (Typ)}
5.1V	120A	390pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD, surge and lightning. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- Provide Surge and Lightning Protection per IEC 61000-4-5 Standard: I_{PP} Max 120A
- 1 Channel of ESD/Surge Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: U-DFN1610-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe (Lead Free Plating).
 Solderable per MIL-STD-202, Method 208 64
- Weight: 0.003 grams (Approximate)

U-DFN1610-2 (Type B)







Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D5V0S1UN2LP1610-7	Standard	D01	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information

D01 YM D01 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September) Dot Denotes Pin 1

Date Code Key

Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G	Η		J	K	L	М	N	0	Р	Q	R



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	I _{PP}	120	Α	8/20µs (Note 7)
ESD Protection – Contact Discharge	V _{ESD_CONTACT}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V_{ESD_AIR}	±30	kV	Standard IEC 61000-4-2

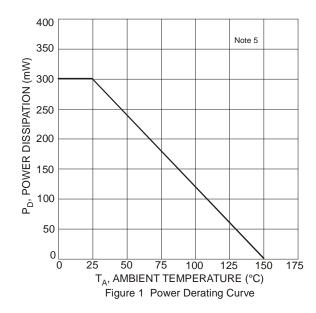
Thermal Characteristics

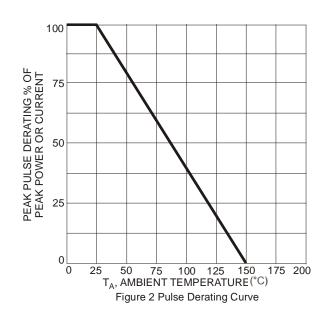
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	300	mW
Thermal Resistance, Junction to Ambient T _A = +25°C	$R_{ heta JA}$	317	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}	_	_	5.0	V	_
Channel Leakage Current (Note 6)	I_R	_	_	0.1	μА	$V_R = V_{RWM}$
Reverse Breakdown Voltage	V_{BR}	5.1	_	_	V	$I_R = 1mA$
		_	6.2	_	V	$I_{PP} = 40A$, $t_P = 8/20 \mu s$
Clamping Voltage, Positive Transients (Note 7)	V _C	_	6.8	_	V	$I_{PP} = 80A$, $t_P = 8/20 \mu s$
		_	7.4	_	V	$I_{PP} = 120A$, $t_P = 8/20\mu s$
Channel Input Capacitance	Ст	_	390		pF	$V_R = 0V$, $f = 1MHz$, Pin1 to Pin2
Dynamic Resistance	R_{DYN}	_	0.03	_	Ω	TLP, $t_P = 100$ ns

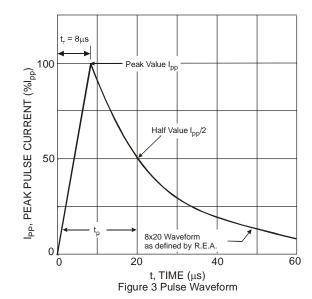
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
 6. Short duration pulse test used to minimize self-heating effect.
- 7. Clamping voltage value is based on an 8x20µs peak pulse current (Ipp) waveform.

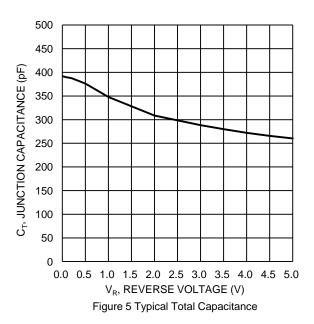


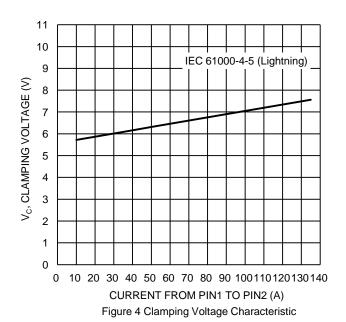


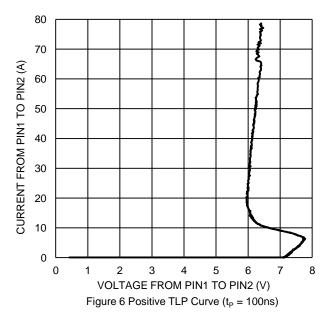










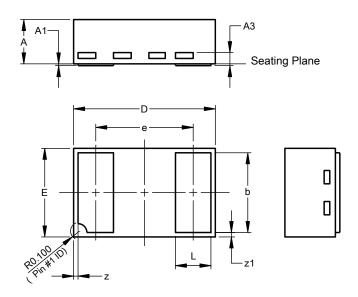




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN1610-2 (Type B)

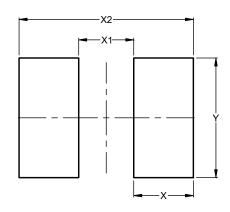


U-DFN1610-2 (Type B)						
Dim	Min	Max	Тур			
Α	0.45	0.55	0.50			
A1	0.00	0.05	0.015			
A3	-	-	0.127			
b	0.85	0.95	0.90			
D	1.55	1.65	1.60			
Е	0.95	1.05	1.00			
е	1	-	1.10			
L	0.35 0.45 0.40					
Z	0.050 REF					
z1	0.050 REF					
All D	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN1610-2 (Type B)



Dimensions	Value (in mm)
Х	0.650
X1	0.600
X2	1.900
Υ	1.300



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